

<b>Notice of References Cited</b>		Application/Control No.	Applicant(s)/Patent Under Reexamination	
		09/837,911	WANG, HUI	
		Examiner	Art Unit	Page 1 of 1
		William T. Leader	1742	

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	C	US-6,497,801	12-2002	Woodruff et al.	204/230.2
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	K	US-			
	L	US-			
	M	US-			

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**NON-PATENT DOCUMENTS**

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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.